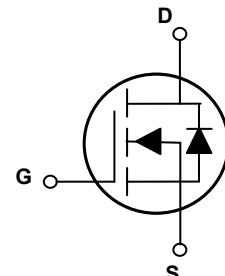
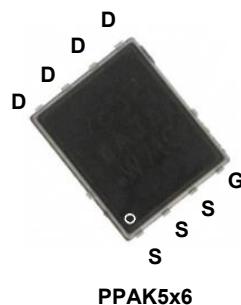


## Main Product Characteristics

|                     |              |
|---------------------|--------------|
| BV <sub>DSS</sub>   | 80V          |
| R <sub>DS(ON)</sub> | 2.2mΩ (Typ.) |
| I <sub>D</sub>      | 170A         |



## Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



## Description

The GSGP2R608 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supplies and a wide variety of other applications.

## Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise specified)

| Parameter  | Symbol           | Max.        | Unit |
|--|------------------|-------------|------|
| Drain-Source Voltage   | V <sub>DS</sub>  | 80          | V    |
| Gate-Source Voltage  | V <sub>GS</sub>  | ±20         | V    |
| Drain Current-Continuous, @Steady-State (T <sub>C</sub> =25°C)         | I <sub>D</sub>   | 170         | A    |
| Drain Current-Continuous, @Steady-State (T <sub>C</sub> =100°C)        |                  | 110         |      |
| Drain Current-Pulsed (T <sub>C</sub> =25°C) <sup>1</sup>               | I <sub>DM</sub>  | 680         | A    |
| Single Pulse Avalanche Energy  | E <sub>AS</sub>  | 380         | mJ   |
| Single Pulse Avalanche Current   | I <sub>AS</sub>  | 39          | A    |
| Power Dissipation (T <sub>C</sub> =25°C) <sup>2</sup>                  | P <sub>D</sub>   | 150         | W    |
| Thermal Resistance, Junction-to-Ambient<br>(PCB Mounted, Steady-State) | R <sub>θJA</sub> | 50          | °C/W |
| Thermal Resistance, Junction-to-Case                                   | R <sub>θJC</sub> | 0.84        | °C/W |
| Operating Junction Temperature Range                                   | T <sub>J</sub>   | -55 To +150 | °C   |
| Storage Temperature Range  | T <sub>STG</sub> | -55 To +150 | °C   |

### Electrical Characteristics ( $T_A=25^\circ\text{C}$ unless otherwise specified)

| Parameter   | Symbol                     | Conditions  | Min. | Typ. | Max.      | Unit             |
|---|----------------------------|---|------|------|-----------|------------------|
| <b>On / Off Characteristics</b>                               |                            |   |      |      |           |                  |
| Drain-Source Breakdown Voltage                                | $\text{BV}_{\text{DSS}}$   | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$  | 80   | -    | -         | V                |
| Drain-Source Leakage Current                                  | $I_{\text{DSS}}$           | $V_{\text{DS}}=80\text{V}, V_{\text{GS}}=0\text{V}, T_J=25^\circ\text{C}$                           | -    | -    | 1         | $\mu\text{A}$    |
|   |                            | $V_{\text{DS}}=80\text{V}, V_{\text{GS}}=0\text{V}, T_J=125^\circ\text{C}$                          | -    | 5.0  | -         | $\mu\text{A}$    |
| Gate-Source Leakage Current                                   | $I_{\text{GSS}}$           | $V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$   | -    | -    | $\pm 100$ | nA               |
| Static Drain-Source On-Resistance                             | $R_{\text{DS}(\text{ON})}$ | $V_{\text{GS}}=10\text{V}, I_{\text{D}}=50\text{A}$   | -    | 2.2  | 2.6       | $\text{m}\Omega$ |
| Gate Threshold Voltage  | $V_{\text{GS}(\text{TH})}$ | $V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=250\mu\text{A}$  | 2.1  | -    | 3.9       | V                |
| <b>Dynamic and Switching Characteristics</b>                  |                            |   |      |      |           |                  |
| Total Gate Charge <sup>3,4</sup>                              | $Q_g$                      | $V_{\text{DD}}=40\text{V}, I_{\text{D}}=50\text{A}, V_{\text{GS}}=10\text{V}$                       | -    | 95   | -         | nC               |
| Gate-Source Charge <sup>3,4</sup>                             | $Q_{\text{gs}}$            |   | -    | 37   | -         |                  |
| Gate-Drain ("Miller") Charge <sup>3,4</sup>                   | $Q_{\text{gd}}$            |   | -    | 17   | -         |                  |
| Gate to Plateau <sup>3,4</sup>                                | $V_{\text{plateau}}$       |   | -    | 5.5  | -         |                  |
| Turn-On Delay Time <sup>3,4</sup>                             | $t_{\text{d}(\text{on})}$  | $V_{\text{DD}}=40\text{V}, R_{\text{G}}=3\Omega, V_{\text{GS}}=10\text{V}, I_{\text{D}}=50\text{A}$ | -    | 32   | -         | nS               |
| Rise Time <sup>3,4</sup>                                      | $t_r$                      |   | -    | 82   | -         |                  |
| Turn-Off Delay Time <sup>3,4</sup>                            | $t_{\text{d}(\text{off})}$ |   | -    | 80   | -         |                  |
| Fall Time <sup>3,4</sup>                                      | $t_f$                      |   | -    | 34   | -         |                  |
| Input Capacitance   | $C_{\text{iss}}$           | $V_{\text{DS}}=40\text{V}, V_{\text{GS}}=0\text{V}, F=1\text{MHz}$                                  | -    | 6022 | -         | pF               |
| Output Capacitance  | $C_{\text{oss}}$           |   | -    | 846  | -         |                  |
| Reverse Transfer Capacitance                                  | $C_{\text{rss}}$           |   | -    | 37   | -         |                  |
| Gate Resistance   | $R_g$                      | $F=1\text{MHz}$   | -    | 3.4  | -         | $\Omega$         |
| <b>Drain-Source Diode Characteristics and Maximum Ratings</b> |                            |   |      |      |           |                  |
| Continuous Source Current (Body Diode)                        | $I_s$                      | MOSFET symbol showing the integral reverse p-n junction diode.                                      | -    | -    | 170       | A                |
| Pulsed Source Current   | $I_{\text{s,pulse}}$       |   | -    | -    | 680       | A                |
| Diode Forward Voltage   | $V_{\text{SD}}$            | $V_{\text{GS}}=0\text{V}, I_{\text{s}}=50\text{A}$  | -    | -    | 1.4       | V                |
| Reverse Recovery Time <sup>3</sup>                            | $t_{\text{rr}}$            | $V_{\text{GS}}=0\text{V}, I_{\text{s}}=50\text{A}, dI_F/dt=100\text{A}/\mu\text{s}$                 | -    | 39   | -         | nS               |
| Reverse Recovery Charge <sup>3</sup>                          | $Q_{\text{rr}}$            |   | -    | 80   | -         | nC               |

Note:

1. Pulse time of 5us, pulse width limited by maximum junction temperature.
2. The dissipated power value will change with the temperature. When it is greater than 25°C, the dissipated power value will decrease by 1.0°C/W for every 1 degree of temperature increase.
3. Pulse test: Pulse width ≤ 300us, duty cycle ≤ 2%.
4. Essentially independent of operating temperature.

## Typical Electrical and Thermal Characteristic Curves

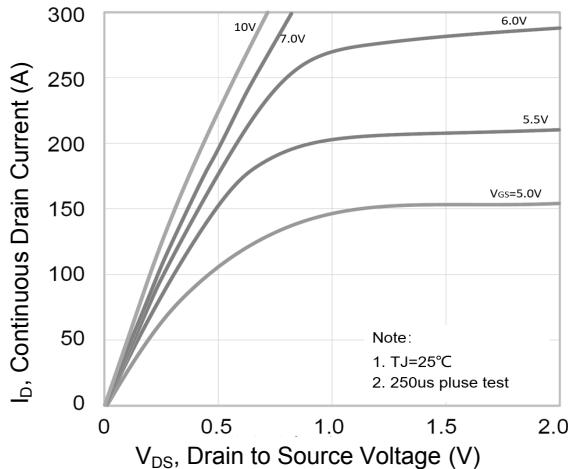


Figure 1. Typical Output Characteristics

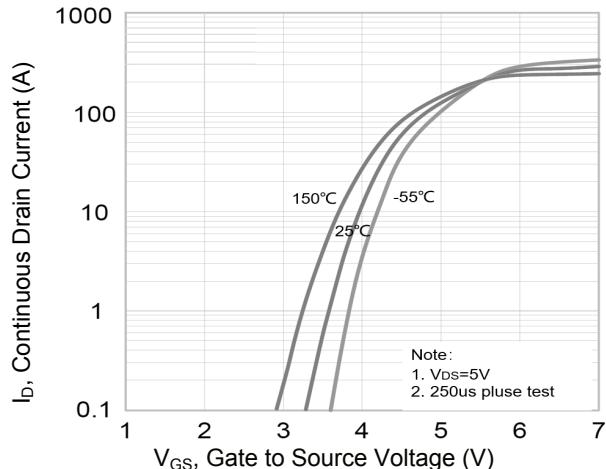


Figure 2. Transfer Characteristics

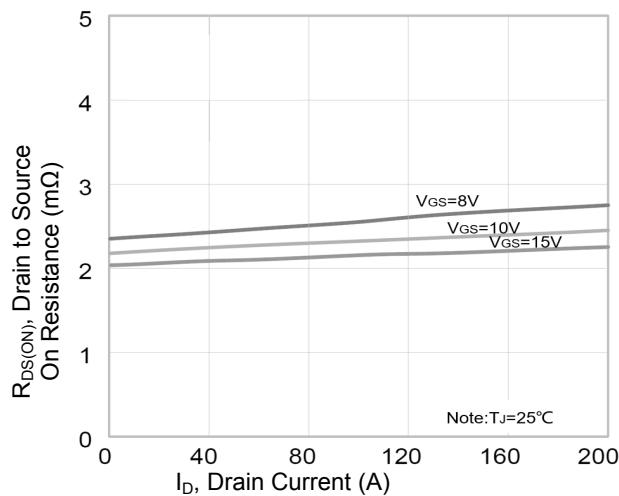


Figure 3.  $R_{DS(ON)}$  vs. Drain Current

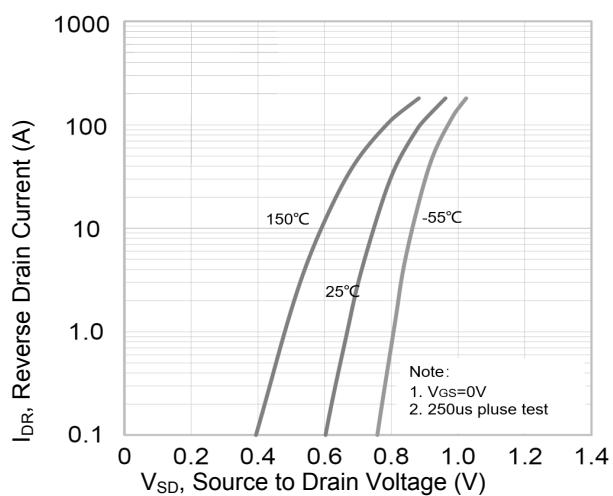


Figure 4. Body Diode Characteristics

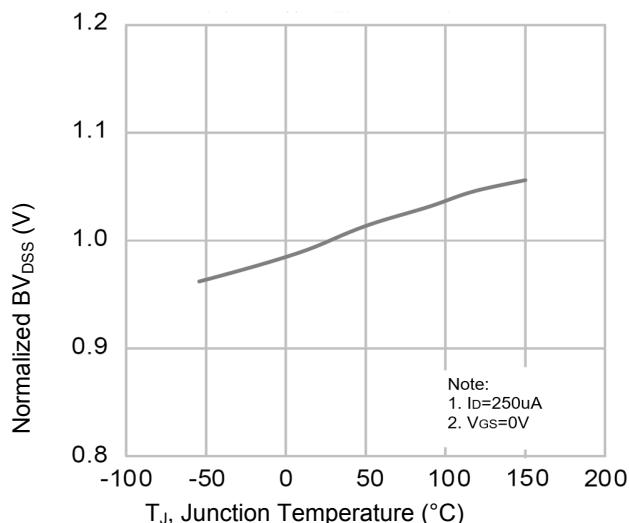


Figure 5. Normalized  $BV_{DSS}$  vs.  $T_J$

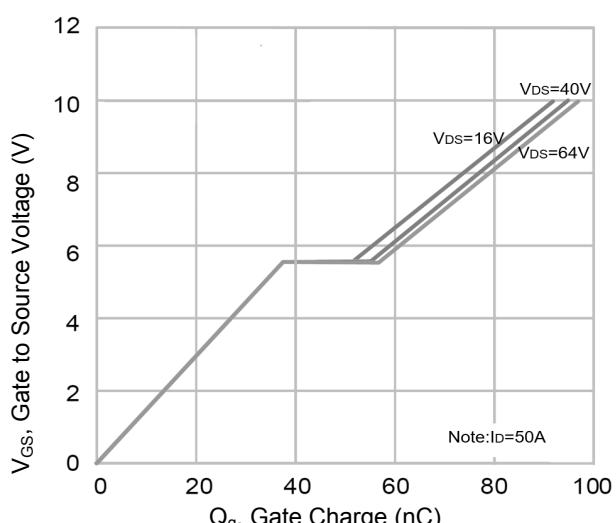
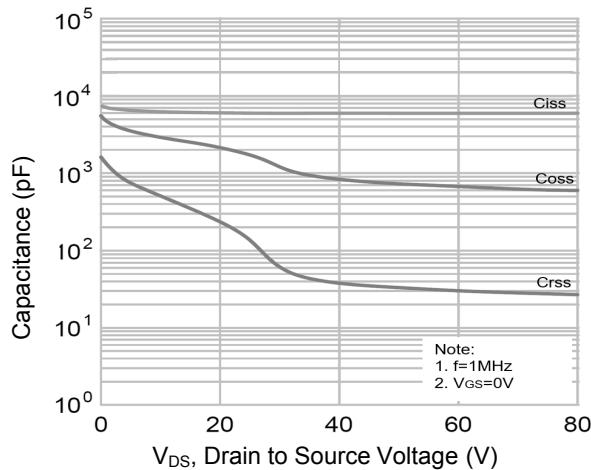
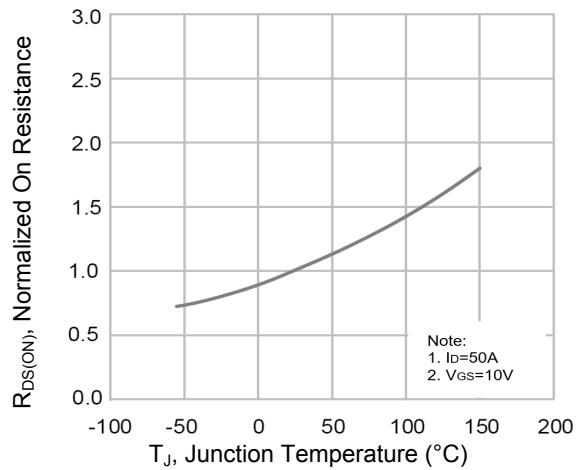


Figure 6. Gate Charge Characteristics

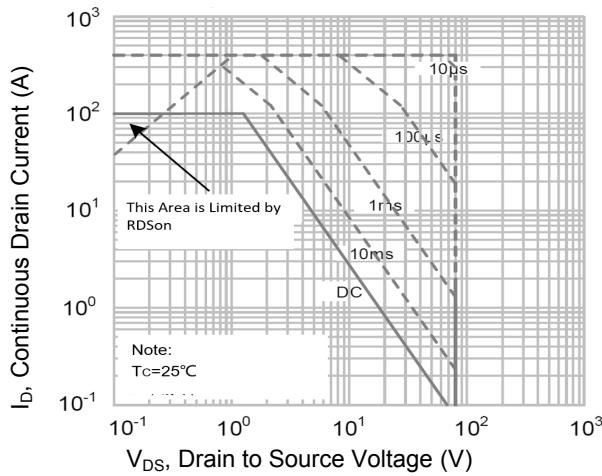
### Typical Electrical and Thermal Characteristic Curves



**Figure 7. Capacitance Characteristics**

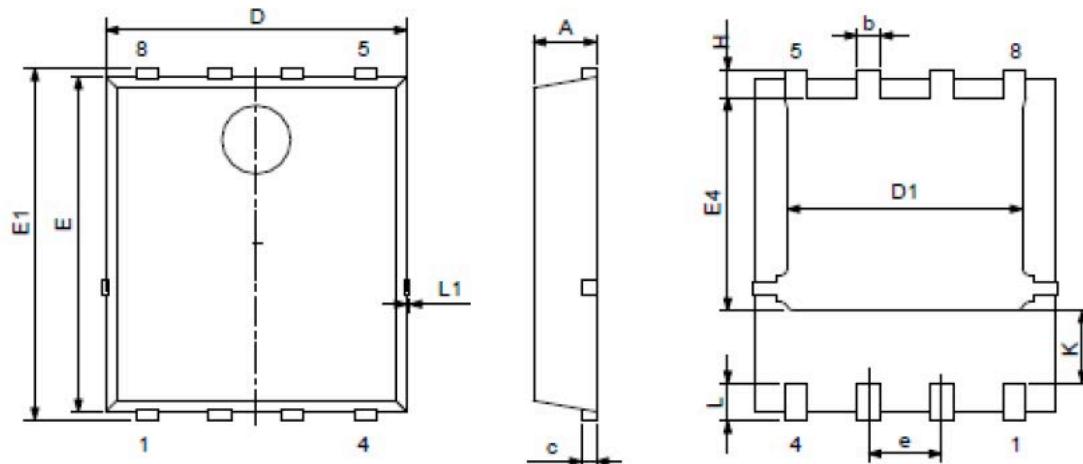


**Figure 8. Normalized  $R_{DS(ON)}$  vs.  $T_J$**



**Figure 9. Maximum Safe Operation Area**

### Package Outline Dimensions (PPAK5x6)



| Symbol | Dimensions in Millimeters |       | Dimensions in Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min                       | Max   | Min                  | Max   |
| A      | 0.900                     | 1.200 | 0.035                | 0.047 |
| c      | 0.154                     | 0.354 | 0.006                | 0.014 |
| D      | 4.800                     | 5.400 | 0.189                | 0.213 |
| E      | 5.660                     | 6.060 | 0.223                | 0.239 |
| D1     | 3.760                     | 4.300 | 0.148                | 0.169 |
| E1     | 5.900                     | 6.350 | 0.232                | 0.250 |
| b      | 0.300                     | 0.550 | 0.012                | 0.022 |
| k      | 1.100                     | 1.500 | 0.043                | 0.059 |
| e      | 1.070                     | 1.370 | 0.042                | 0.054 |
| E4     | 3.340                     | 3.920 | 0.131                | 0.154 |
| L      | 0.300                     | 0.710 | 0.012                | 0.028 |
| L1     | -                         | 0.120 | -                    | 0.005 |
| H      | 0.400                     | 0.710 | 0.016                | 0.028 |